PTO/SB/21 (09-04) Approved for use through 07/31/2006, OMB 0651-0031

THADE		A . I' . at a Mi mahe		10/700 000	
TRANSMITTAL		Application Numbe	<u>r</u> /	10/792,222	
FORM	•	Filing Date		March 3, 2004	
	1	First Named Invent	tor !	Moden et al.	
	1	Art Unit	!	3729	
(to be used for all correspondence after initial filing) Total Number of Pages in This Submission 10		Examiner Name		M. Trinh	
		Attorney Docket Nu	umber	2269-3389.8US (97-0638.08/US)	
	ENCLO	SURES (check all tha	at apply)		
Fee Transmittal Form	Drawing(s)			After Allowance Communication to TC	
Fee Attached	Licensing	g-related Papers		Appeal Communication to Board of Appeals and Interferences	
Amendment in Response to Office Action dated November 10, 2005	Petition			Appeal Communication to TC (Appeal Notice, Brief, Reply Brief)	
After Final	Provisiona	o Convert to a nal Application		Proprietary Information	
Affidavits/declaration(s)		Attorney, Revocation of Correspondence Addi	ress	Status Letter	
Extension of Time Request	Terminal Disclaimer			Other Enclosure(s) (please identify below):	
Express Abandonment Request	Request for Refund				
		nber of CD(s)	1		
Information Disclosure Statement		ndscape Table on CD			
Certified Copy of Priority Document(s)	Remarks The Commiss	Remarks The Commissioner is authorized to charge any additional fees required but not submitted			
Reply to Missing Parts/ Incomplete Application	with any document or request requiring fee pay			yment under 37 C.F.R. §§ 1.16 AND 1.17 TO	
Reply to Missing Parts	Deposit Account 20-1469 during pendency of this application.				
under 37 CFR1.52 or 1.53	1				
SIGI	NATURE OF	APPLICANT, ATTOR	RNEY, O	R AGENT	
Firm	TraskBritt, P.C.				
Signature	Sames R. Dunger				
Printed Name		James R. Duzan			
Date	February 9, 200	J6	Reg. No.	28,393	
	CERTIFICA	ATE OF TRANSMISS	ION/MAI	ILING	
I hereby certify that this correspondent	ce is being fac	simile transmitted to the	ne USPTO	O or deposited with the United States Posta Commissioner for Patents, P.O. Box 1450	

This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date

February 9, 2006

Leta M. Howard

Typed or printed name



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Moden et al.

Serial No.: 10/792,222

Filed: March 3, 2004

For: A METHOD FOR FORMING A LOW PROFILE MULTI-IC CHIP PACKAGE

CONNECTOR (as amended)

Confirmation No.: 4777

Examiner: M. Trinh

Group Art Unit: 3729

Attorney Docket No.: 2269-3389.8US

(97-0638.08/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

February 9, 2006

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of November 10, 2005 whose initial period of response is set to expire on February 10, 2006.

Amendments to the Title begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 6 of this paper.

IN THE TITLE:

Please amend the Title as follows:

A METHOD FOR FORMING A LOW PROFILE MULTI-IC CHIP PACKAGE CONNECTOR